imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PHOTONIC Silicon Photodiode, Blue Enhanced Photoconductive DETECTORS INC. Type PDB-C163



PACKAGE DIMENSIONS INCH [mm] PHOTODIODE 075 [1.91] CHIF [4.24] .055 [1.40] .068 [1.73] .050 [1.27] .019 [0.48] .025 [0.64] .068 [1.73] .250 [6.35] METALIZED CERAMIC CLEAR ENCAPSULATE 2X SOLDER PLATE CATHODE SOLDER PAD 068 [1.73] SQ ANODE SOLDER PAD .059 [1.50] SQ ACTIVE AREA METALIZED CERAMIC PACKAGE ACTIVE AREA = 2.03 mm²

FEATURES

- High speed
- Specially matched to 660 nm and near IR emitters

DESCRIPTION

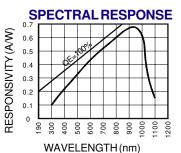
The **PDB-C163** is a silicon, PIN planar diffused, photodiode. Ideal for many OEM pulsed oximeter probe assemblies. Packaged in a metalized ceramic substrate with top side pre-tinned solder contacts.

APPLICATIONS

- Pulsed oximetry
- Glucometers
- Pulse meters

ABSOLUTE MAXIMUM RATING (TA=25°C unless otherwise noted)

				,
SYMBOL	PARAMETER	MIN	MAX	UNITS
V _{BR}	Reverse Voltage		100	V
T _{stg}	Storage Temperature	-45	+100	°C
T _o	Operating Temperature Range	-40	+80	°C
T _s	Soldering Temperature*		+240	°C
Ι	Light Current		5.0	mA



*1/16 inch from case for 3 secs max

ELECTRO-OPTICAL CHARACTERISTICS (TA=25°C unless otherwise noted)

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _{sc}	Short Circuit Current	H = 100 fc, 2850 K	20	25		$\mu \mathbf{A}$
I _D	Dark Current	H = 0, V _R = 10 V		1.0	10	nA
R _{SH}	Shunt Resistance	H = 0, V _R = 10 mV	100	500		MΩ
TCR _{SH}	RSH Temp. Coefficient	H = 0, V _R = 10 mV		-8		% / °C
C	Junction Capacitance	H = 0, V _R = 10 V**		7		рF
λrange	Spectral Application Range	Spot Scan	350		1100	nm
λρ	Spectral Response - Peak	Spot Scan		950		nm
V _{BR}	Breakdown Voltage	I = 10 μA	50	75		V
NEP	Noise Equivalent Power	V _R = 10 V @ Peak		1.0x10 ⁻¹⁴		W/ \sqrt{Hz}
tr	Response Time	RL = 1 KΩ V _R = 50 V		35		nS

Information in this technical data sheet is believed to be correct and reliable. However, no responsibility is assumed for possible inaccuracies or omission. Specifications are subject to change without notice. ** f = 1 MHz [FORM NO. 100-PDB-C163 REV A]